

Low Power Peak EMI Reducing Solution

Features

- Generates an EMI optimized clock signal at the output.
- Integrated loop filter components.
- Operates with a 3.3V / 2.5V Supply.
- Operating current less than 4mA.
- Low power CMOS design.
- Input frequency range: 3MHz to 5MHz for 2.5V

: 3MHz to 6MHz for 3.3V

- Generates a 1X low EMI spread spectrum clock of the input frequency.
- Frequency deviation: ±1% @ 3MHz
- Available in 6-pin TSOT-23, 8-pin SOIC and 8-pin TSSOP packages.

Product Description

The ASM3P2759A is a versatile spread spectrum frequency modulator designed specifically for a wide range of clock frequencies. The ASM3P2759A reduces electromagnetic interference (EMI) at the clock source, allowing system wide reduction of EMI of all clock dependent signals. The ASM3P2759A allows significant system cost savings by reducing the number of circuit board layers ferrite beads, shielding that are traditionally required to pass EMI regulations.

The ASM3P2759A uses the most efficient and optimized modulation profile approved by the FCC and is implemented by using a proprietary all digital method.

The ASM3P2759A modulates the output of a single PLL in order to "spread" the bandwidth of a synthesized clock, and more importantly, decreases the peak amplitudes of its harmonics. This results in significantly lower system EMI compared to the typical narrow band signal produced by oscillators and most frequency generators. Lowering EMI by increasing a signal's bandwidth is called 'spread spectrum clock generation'.

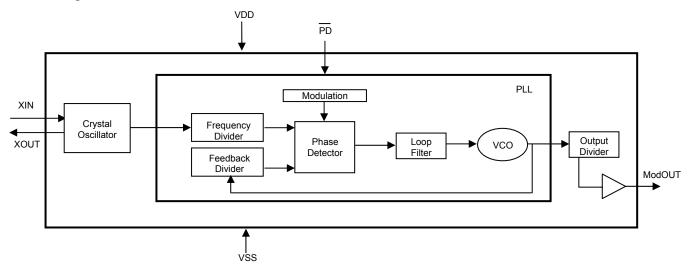
Applications

The ASM3P2759A is targeted towards all portable devices with very low power requirements like MP3 players and digital still cameras.

Key Specifications

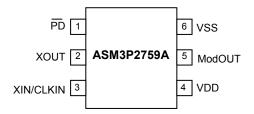
Description	Specification
Supply voltages	VDD = 3.3V / 2.5V
Cycle-to-Cycle Jitter	200pS (Max)
Output Duty Cycle	45/55%
Modulation Rate Equation	F _{IN} /128
Frequency Deviation	±1% @ 3MHz

Block Diagram





Pin Configuration (6-pin TSOT- 23 Package)

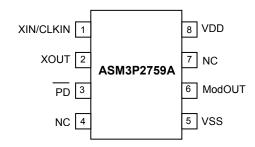


Pin Description

Pin#	Pin Name	Туре	Description				
1	1 		Power-down control pin. Pull low to enable power-down mode. Connect to VDD if not used.				
2	XOUT	0	Crystal connection. If using an external reference, this pin must be left unconnected.				
3	XIN/CLKIN	I	Crystal connection or external reference frequency input. This pin has dual functions. It can be connected either to an external crystal or an external reference clock.				
4	VDD	Р	Power supply for the entire chip				
5	ModOUT	0	Spread spectrum clock output.				
6	VSS	Р	Ground connection.				



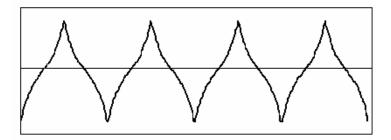
Pin Configuration (8-pin SOIC and TSSOP Packages)



Pin Description

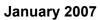
Pin#	Pin Name	Type	Description
1	XIN/CLKIN	I	Crystal connection or external reference frequency input. This pin has dual functions. It can be connected either to an external crystal or an external reference clock.
2	XOUT	0	Crystal connection. If using an external reference, this pin must be left unconnected.
3	— PD	I	Power-down control pin. Pull low to enable power-down mode. Connect to VDD if not used.
4	NC	-	No connect.
5	VSS	Р	Ground connection.
6	ModOUT	0	Spread spectrum clock output.
7	NC	-	No connect.
8	VDD	Р	Power supply for the entire chip

Modulation Profile



Specification

Description		Specification
Fraguency Pango	For 2.5V Supply	3MHz < CLKIN < 5MHz
Frequency Range	For 3.3V Supply	3MHz < CLKIN < 6MHz
Modulation Equation		F _{IN} /128
Frequency Deviation		±1% @ 3MHz





Absolute Maximum Ratings

Symbol	Parameter	Rating	Unit
VDD, V_{IN}	Voltage on any pin with respect to Ground	-0.5 to +4.6	٧
T _{STG}	Storage temperature	-65 to +125	°C
T _A	Operating temperature	-40 to +85	°C
Ts	Max. Soldering Temperature (10 sec)	260	°C
TJ	Junction Temperature	150	°C
T_DV	Static Discharge Voltage	2	KV
Note: These are s	(As per JEDEC STD22- A114-B) stress ratings only and are not implied for functional use. Exposure to absolute maximum ratings f	or prolonged periods of time i	may affect

DC Electrical Characteristics for 2.5V Supply (Test condition: All parameters are measured at room temperature (+25°C) unless otherwise stated)

Symbol	Parameter	Min	Тур	Max	Unit
V _{IL}	Input low voltage	VSS - 0.3	-	0.8	V
V _{IH}	Input high voltage	2.0	-	VDD + 0.3	V
I _{IL}	Input low current	-	-	-35	μΑ
I _{IH}	Input high current	-	-	35	μΑ
I _{XOL}	XOUT output low current (@0.5V, VDD=2.5V)	-	3	-	mA
I _{XOH}	XOUT output high current (@1.8V, VDD=2.5V)	-	3	-	mA
V _{OL}	Output low voltage (VDD = 2.5 V, I _{OL} = 8mA)	-	-	0.6	V
V _{OH}	Output high voltage (VDD = 2.5 V, I _{OH} = 8mA)	1.8	-	-	V
I _{DD}	Static supply current*	-	-	10	uA
Icc	Dynamic supply current (2.5V, 3MHz and with no load)	-	2.0	-	mA
VDD	Operating Voltage	2.375	2.5	2.625	V
t _{ON}	Power-up time (first locked cycle after power-up)**	-	-	5	mS
Zout	Output impedance	-	50	_	Ω

	Parameter	Min	Тур	Max	Unit
Input frequency		3	-	5	MHz
Output frequency	put frequency			5	MHz
Frequency Deviation Input Frequency = 3MHz Input Frequency = 5MHz	Input Frequency = 3MHz	-	±1	_	%
	-	±0.6	-	/0	
Output rise time (measured	Output rise time (measured from 0.7V to 1.7V)			1.2	nS
Output fall time (measured fi	Output fall time (measured from 1.7V to 0.7V)		0.9	1.1	nS
Jitter (cycle to cycle)	ter (cycle to cycle)		-	200	pS
Output duty cycle	45	50	55	%	
	Input frequency Output frequency Frequency Deviation Output rise time (measured for a comput fall time (measured fall time (measu	Input frequency Output frequency Frequency Deviation Input Frequency = 3MHz Input Frequency = 5MHz Output rise time (measured from 0.7V to 1.7V) Output fall time (measured from 1.7V to 0.7V) Jitter (cycle to cycle)	Input frequency Output frequency 3 Frequency Deviation Input Frequency = 3MHz Input Frequency = 5MHz Output rise time (measured from 0.7V to 1.7V) Output fall time (measured from 1.7V to 0.7V) Jitter (cycle to cycle) -	Input frequency 3 -	Input frequency 3 - 5



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rev 1.7

DC Electrical Characteristics for 3.3V Supply (Test condition: All parameters are measured at room temperature (+ 25°C) unless otherwise stated)

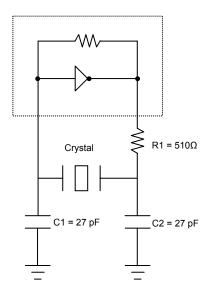
Symbol	Parameter	Min	Тур	Max	Unit
V _{IL}	Input low voltage	VSS - 0.3	-	0.8	V
V _{IH}	Input high voltage	2.0	-	VDD + 0.3	V
I _{IL}	Input low current	-	-	-35	μA
I _{IH}	Input high current	-	-	35	μA
I _{XOL}	XOUT output low current (@0.4V, VDD=3.3V)	-	3	-	mA
I _{XOH}	XOUT output high current (@2.5V, VDD=3.3V)	-	3	-	mA
V _{OL}	Output low voltage (VDD = 3.3 V, I _{OL} = 8mA)	-	-	0.4	V
V _{OH}	Output high voltage (VDD = 3.3 V, I _{OH} = 8mA)	2.5	-	-	V
I _{DD}	Static supply current*	-		10	uA
Icc	Dynamic supply current (3.3V, 3MHz and with no load)	-	2.5	-	mA
VDD	Operating Voltage	2.7	3.3	3.6	V
t _{ON}	Power-up time (first locked cycle after power-up)**	-	-	5	mS
Z _{OUT}	Output impedance	-	45	-	Ω
	and PD pin are pulled low				

AC Electrical Characteristics for 3.3V Supply

Symbol	Parameter			Тур	Max	Unit
CLKIN	Input frequency	,	3	-	6	MHz
ModOUT	Output frequen	су	3	-	6	MHz
f	Frequency Deviation	Input Frequency = 3MHz	-	±1	-	%
f _d		Input Frequency = 6MHz	-	±0.55	-	
t _{LH} *	Output rise time	Output rise time (measured from 0.8 to 2.0V)			1.2	nS
t _{HL} *	Output fall time	Output fall time (measured at 2.0V to 0.8V)			1.0	nS
t _{JC}	Jitter (cycle to c	Jitter (cycle to cycle)			200	pS
t _D	Output duty cyc	45	50	55	%	
*t _{LH} and t _{HL} are measur	*t _{LH} and t _{HL} are measured into a capacitive load of 15pF					



Typical Crystal Oscillator Circuit



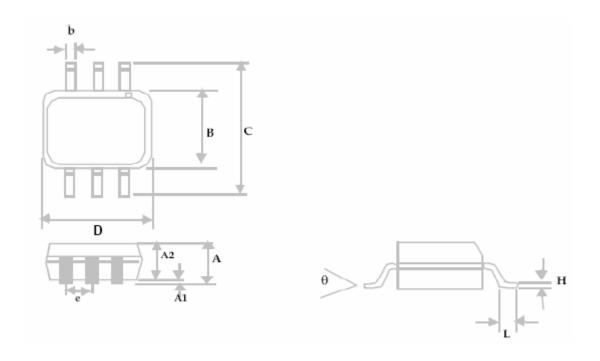
Typical Crystal Specifications

Fundamental AT cut parallel resonant crystal				
Nominal frequency	4.800MHz			
Frequency tolerance	± 50 ppm or better at 25°C			
Operating temperature range	-25°C to +85°C			
Storage temperature	-40°C to +85°C			
Load capacitance	18pF			
Shunt capacitance	7pF maximum			
ESR	25 Ω			



Package Information

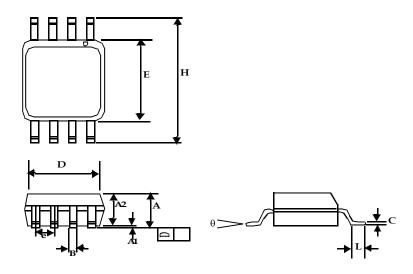
6-pin TSOT-23 Package



	Dimensions				
Symbol	Inches		Millim	neters	
	Min	Max	Min	Max	
Α		0.04		1.00	
A1	0.00	0.004	0.00	0.10	
A2	0.033	0.036	0.84	0.90	
b	0.012	0.02	0.30	0.50	
Н	0.005	BSC	0.127 BSC		
D	0.114	BSC	2.90	BSC	
В	0.06	BSC	1.60	BSC	
е	0.0374	4 BSC	0.950	BSC	
С	0.11 BSC		2.80 BSC		
L	0.0118	0.02	0.30	0.50	
θ	0°	4°	0°	4°	



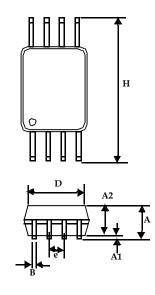
8-Pin SOIC Package

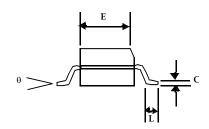


	Dimensions				
Symbol	Inc	hes	Millimeters		
	Min	Max	Min	Max	
A1	0.004	0.010	0.10	0.25	
Α	0.053	0.069	1.35	1.75	
A2	0.049	0.059	1.25	1.50	
В	0.012	0.020	0.31	0.51	
С	0.007	0.010	0.18	0.25	
D	0.193	BSC	4.90	BSC	
Е	0.154	BSC	3.91	BSC	
е	0.050 BSC		1.27 BSC		
Н	0.236	BSC	6.00 BSC		
L	0.016	0.050	0.41	1.27	
θ	0°	8°	0°	8°	



8-Pin TSSOP Package





	Dimensions				
Symbol	Inches		Millimeters		
	Min	Max	Min	Max	
А		0.043		1.10	
A1	0.002	0.006	0.05	0.15	
A2	0.033	0.037	0.85	0.95	
В	0.008	0.012	0.19	0.30	
С	0.004	0.008	0.09	0.20	
D	0.114	0.122	2.90	3.10	
E	0.169	0.177	4.30	4.50	
е	0.026 BSC		0.65 BSC		
Н	0.252 BSC		6.40 BSC		
L	0.020	0.028	0.50	0.70	
θ	0°	8°	0°	8°	

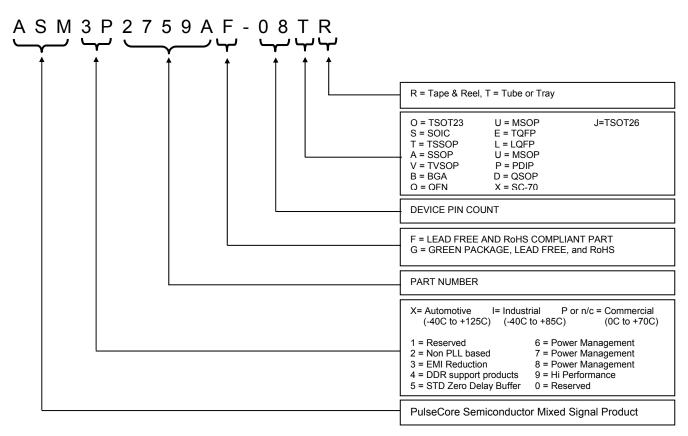


Ordering Information

Part Number	Marking	Package Type	Temperature
ASM3P2759AF-06OR	O4LL	6-Pin TSOT-23, TAPE & REEL, Pb Free	Commercial
ASM3P2759AF-08TT	3P2759AF	8-Pin TSSOP, TUBE, Pb Free	Commercial
ASM3P2759AF-08TR	3P2759AF	8-Pin TSSOP, TAPE & REEL, Pb Free	Commercial
ASM3P2759AF-08ST	3P2759AF	8-Pin SOIC, TUBE, Pb Free	Commercial
ASM3P2759AF-08SR	3P2759AF	8-Pin SOIC, TAPE & REEL, Pb Free	Commercial
ASM3P2759AG-06OR	O3LL	6-Pin TSOT-23, TAPE & REEL, Green	Commercial
ASM3P2759AG-08TT	3P2759AG	8-Pin TSSOP, TUBE, Green	Commercial
ASM3P2759AG-08TR	3P2759AG	8-Pin TSSOP, TAPE & REEL, Green	Commercial
ASM3P2759AG-08ST	3P2759AG	8-Pin SOIC, TUBE, Green	Commercial
ASM3P2759AG-08SR	3P2759AG	8-Pin SOIC, TAPE & REEL, Green	Commercial
ASM3I2759AF-06OR	O5LL	6-Pin TSOT-23, TAPE & REEL, Pb Free	Industrial
ASM3I2759AF-08TT	3I2759AF	8-Pin TSSOP, TUBE, Pb Free	Industrial
ASM3I2759AF-08TR	3I2759AF	8-Pin TSSOP, TAPE & REEL, Pb Free	Industrial
ASM3I2759AF-08ST	3I2759AF	8-Pin SOIC, TUBE, Pb Free	Industrial
ASM3I2759AF-08SR	3I2759AF	8-Pin SOIC, TAPE & REEL, Pb Free	Industrial
ASM3I2759AG-06OR	O6LL	6-Pin TSOT-23, TAPE & REEL, Green	Industrial
ASM3I2759AG-08TT	3I2759AG	8-Pin TSSOP, TUBE, Green	Industrial
ASM3I2759AG-08TR	3I2759AG	8-Pin TSSOP, TAPE & REEL, Green	Industrial
ASM3I2759AG-08ST	3I2759AG	8-Pin SOIC, TUBE, Green	Industrial
ASM3I2759AG-08SR	3I2759AG	8-Pin SOIC, TAPE & REEL, Green	Industrial



Device Ordering Information



Licensed under U.S Patent Nos 5,488,627 and 5,631,921





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Note: This product utilizes US Patent # 6,646,463 Impedance Emulator Patent issued to PulseCore Semiconductor, dated 11-11-2003

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